

SMAG Plastic-Encapsulate Diodes

Schottky Rectifier

Features

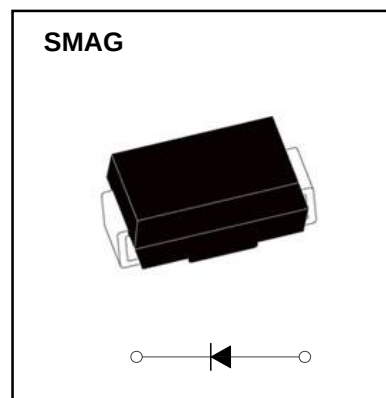
- I_o 2A
- V_{RRM} 60V
- High surge current capability
- Polarity: Color band denotes cathode
- Low V_f

Applications

- Rectifier

Marking

- SS26L



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	SS26L
Repetitive Peak Reverse Voltage	V_{RRM}	V		60
Maximum RMS Voltage	V_{RMS}	V		42
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load	2.0
Surge(Non-repetitive)Forward Current	I_{FSM}	A	60Hz Half-sine wave, 1 cycle, $T_a=25^\circ\text{C}$	70
Junction Temperature	T_J	$^\circ\text{C}$		-55~+150
Storage Temperature	T_{STG}	$^\circ\text{C}$		-55~+150

Electrical Characteristics ($T_a=25^\circ\text{C}$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		SS26L
Peak Forward Voltage	V_F	V	$I_F=2\text{A}$	$T_a=25^\circ\text{C}$	0.56
Peak Reverse Current	I_{RRM1}	mA	$V_{RM}=V_{RRM}$	$T_a=25^\circ\text{C}$	0.1
	I_{RRM2}			$T_a=100^\circ\text{C}$	10
Thermal Resistance(Typical)	$R_{\theta J-A}$	$^\circ\text{C/W}$	Between junction and ambient		55
	$R_{\theta J-L}$		Between junction and lead		17

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

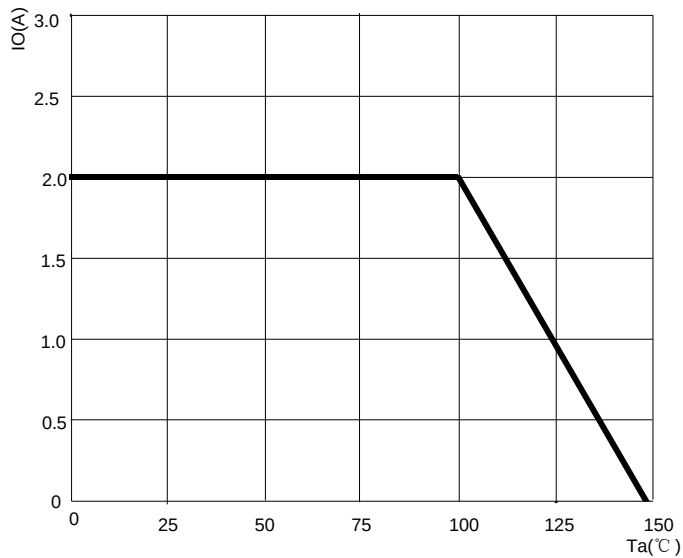


FIG.2: MAXIMUM NON-REPETITIVE FORWARD URGE CURRENT

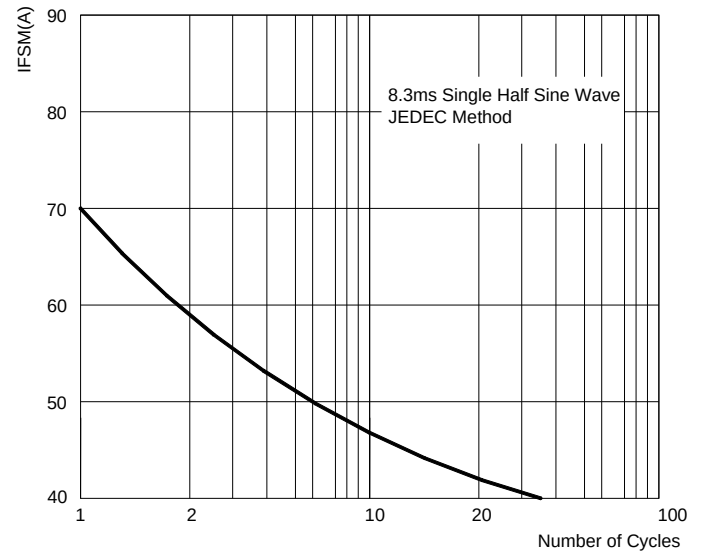


FIG.3: TYPICAL FORWARD CHARACTERISTICS

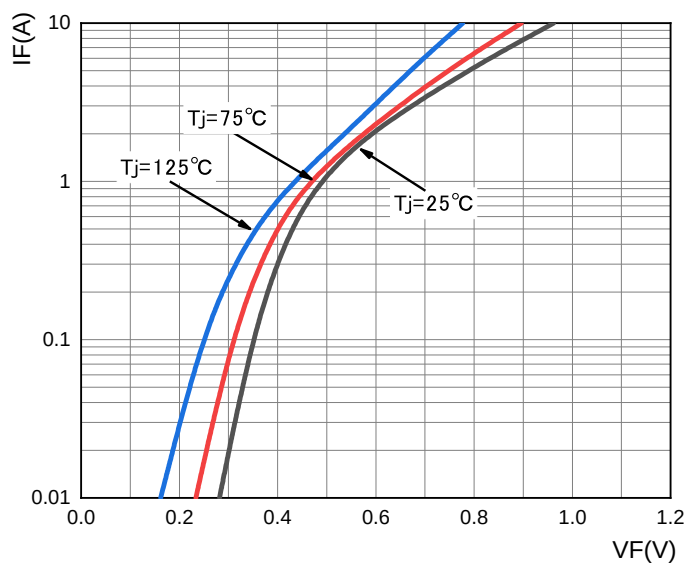
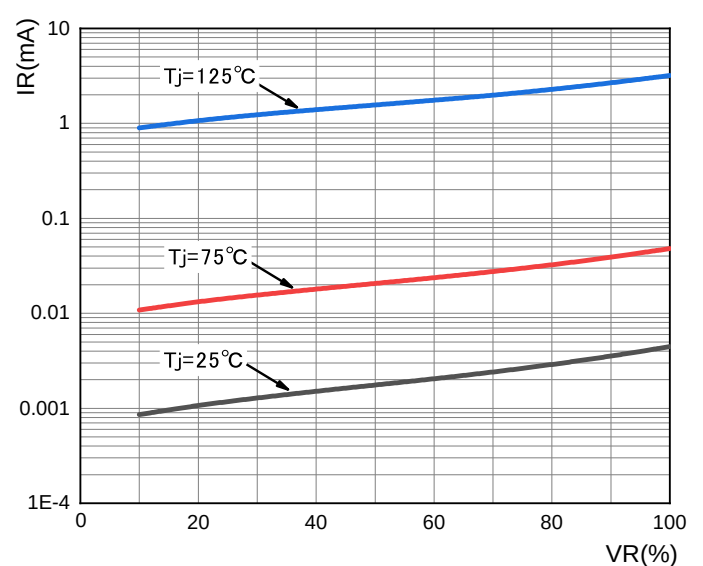
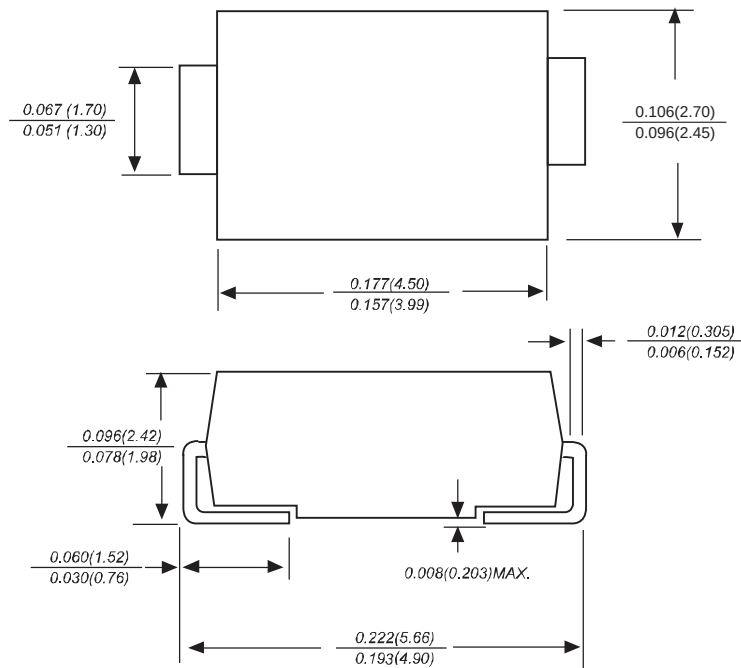


FIG.4: TYPICAL REVERSE CHARACTERISTICS

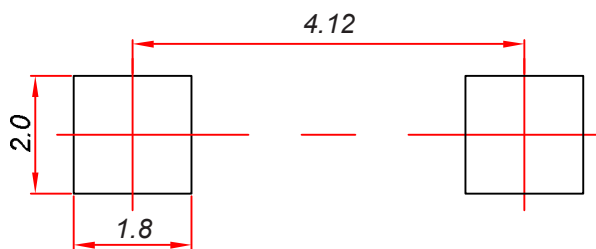


SMAG Package Outline Dimensions



Dimensions in inches and (millimeters)

SMAG Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

JSHD reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSHD does not assume any liability arising out of the application or use of any product described herein.

Reel Taping Specifications For Surface Mount Devices–SMAG

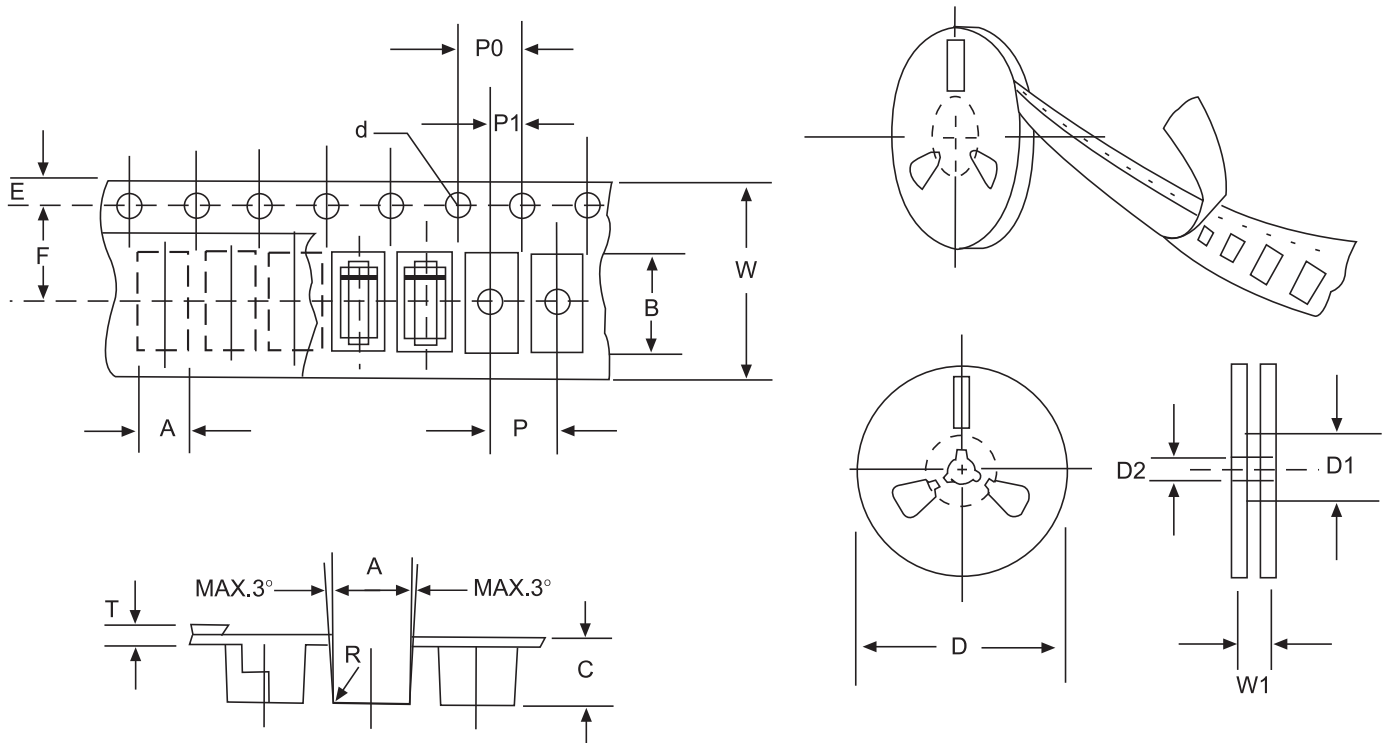


FIG:CONFIGURATION OF AXIAL TAPING

ITEM	SYMBOL	SMAG mm(inch)
Carrier width	A	2.79±0.1(0.110±0.004)
Carrier length	B	5.33±0.1(0.210±0.004)
Carrier depth	C	2.36±0.1(0.093±0.004)
Sprocket hole	d	1.5±0.05(0.059±0.0002)
Reel outside diameter	D	330/178±2.0(13/7.0±0.79)
Reel inner diameter	D1	8.0±0.2(0.315±0.008)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Sprocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	5.5±0.05(0.217±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Total tape thickness	T	0.28±0.02(0.011±0.0008)
Tape width	W	12.0±0.2(0.472±0.008)
Reel width	W1	16.8±2.0(0.661±0.079)

NOTE: Devices are packed in accordance with EIA standard RS-481-A and specification given above.